TOSHIBA Field Effect Transistor Silicon N-Channel MOS Type (π -MOSVI)

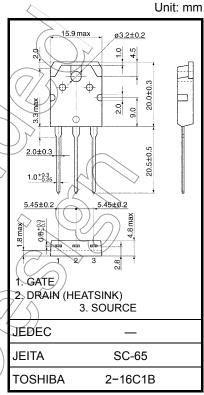
2SK3903

Switching Regulator Applications

- Low drain-source ON resistance: R_{DS} (ON) = 0.32 Ω (typ.)
- High forward transfer admittance: $|Y_{fS}| = 7.5 \text{ S (typ.)}$
- Low leakage current: I_{DSS} = 100 μA (max) (V_{DS} = 600 V)
- Enhancement model: V_{th} = 2.0 to 4.0 V (V_{DS} = 10 V, I_D = 1 mA)

Absolute Maximum Ratings (Ta = 25°C)

					(1)
Characteristic			Symbol	Rating	Dnit
Drain-source voltage			V_{DSS}	600	(v)
Drain-gate voltage ($R_{GS} = 20 \text{ k}\Omega$)			V_{DGR}	600)>
Gate-source voltage			V_{GSS}	±30	\
Drain current	DC	(Note 1)	ID	14	A
Drain current	Pulse	(Note 1)	I _{DP}	56	A
Drain power dissipation (Tc = 25°C)			PD	150	W
Single pulse avalanche energy (Note 2)			EAS	806	mJ mJ
Avalanche current			IAR)) 14	A
Repetitive avalanche energy (Note 3)			EAR	15	mJ
Channel temperature			T _{ch}	150	∫\°C
Storage temperature range			Tstg	-55 to 150	ç
	•		// \		



Weight: 4.6 g (typ.)

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Thermal Characteristics

Characteristic	Symbol	Max	Unit
Thermal resistance, channel to case	Rth (ch-c)	0.833	°C/W
Thermal resistance, channel to ambient	R _{th (ch-a)}	50	°C/W

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Note 1: Ensure that the channel temperature does not exceed 150°C during use of the device.

Note 2: $V_{DD} = 90 \text{ V}$, $T_{ch} = 25^{\circ}\text{C}$, L = 7.2 mH, $R_G = 25 \Omega$, $I_{AR} = 14 \text{ A}$

Note 3: Repetitive rating: pulse width limited by max junction temperature

This transistor is an electrostatic-sensitive device. Handle with care.

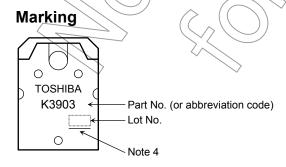
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Electrical Characteristics (Ta = 25°C)

Char	acteristic	Symbol	Test Condition	Min	Тур.	Max	Unit		
Gate leakage curi	ate leakage current I _{GSS}		$V_{GS} = \pm 25 \text{ V}, V_{DS} = 0 \text{ V}$	_	_	±10	μА		
Gate-source brea	kdown voltage	V (BR) GSS	$I_G = \pm 10 \ \mu A, \ V_{DS} = 0 \ V$	±30	_	_	V		
Drain cut-off curre	current I _{DSS} V _{DS}		V _{DS} = 600 V, V _{GS} = 0 V		_	100	μА		
Drain-source brea	Orain-source breakdown voltage		$I_D = 10$ mA, $V_{GS} = 0$ V	600	_	_	V		
Gate threshold voltage		V _{th}	V _{DS} = 10 V, I _D = 1 mA	2.0) >_	4.0	V		
Drain-source on resistance		R _{DS} (ON)	V _{GS} = 10 V, I _D = 7 A	<u> </u>	0.32	0.44	Ω		
Forward transfer admittance		Y _{fs}	V _{DS} = 10 V, I _D = 7 A	2.1	7.5	_	S		
Input capacitance		C _{iss}		_	3100	_			
Reverse transfer	capacitance	C _{rss}	V _{DS} = 25 V, V _{GS} = 0 V, f = 1 MHz	<u> </u>	20	_	pF		
Output capacitano	ce	C _{oss}		_	270	_			
Switching time	Rise time	t _r	V _{GS} V _{OUT}	- (70/	<u>></u>			
	Turn-on time	t _{on}	0 V		130) —			
	Fall time	t _f	$\begin{array}{c c} & & & \\ & & \\ & & & \\ & & & \\ & & & \\ & & \\ & & & \\ & & & \\ & & & \\ & & & \\ & & & \\ & & & \\ &$	7 (5)	70	_	ns		
	Turn-off time	t _{off}	Duty \leq 1%, $t_W = 10 \mu s$ $V_{DD} \approx 200 \text{ V}$) –	280	_			
Total gate charge (gate-source plus gate-drain)		Qg		_	62	_			
Gate-source charge		Qgs	$V_{DD} \approx 400 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 14 \text{ A}$	_	40	_	nC		
Gate-drain ("Miller") charge		Qgd		_	22	_			

Source-Drain Ratings and Characteristics (Ta = 25°C)

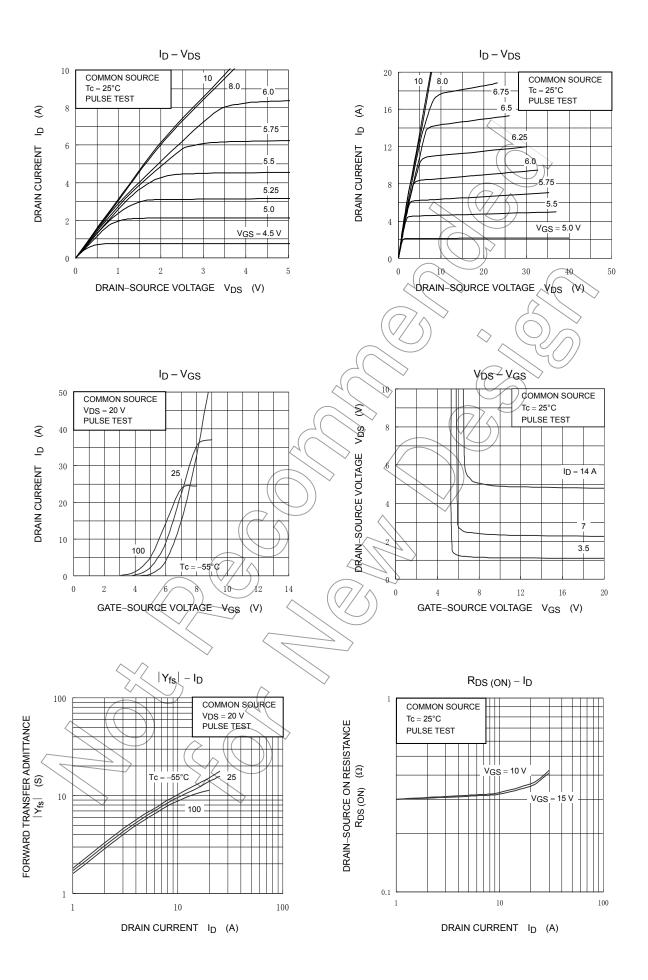
Characteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)	I _{DR}	_	_	_	14	Α
Pulse drain reverse current (Note 1)	IDRR	2	_	_	56	Α
Forward voltage (diode)	V _{DSF}	I _{DR} = 14 A, V _{GS} = 0 V	_	_	-1.7	V
Reverse recovery time	⟨> t _{rr}	I _{DR} = 14 A, V _{GS} = 0 V,	_	1300	_	ns
Reverse recovery charge	Qrr	dI _{DR} /dt = 100 A/μs	_	18	_	μС



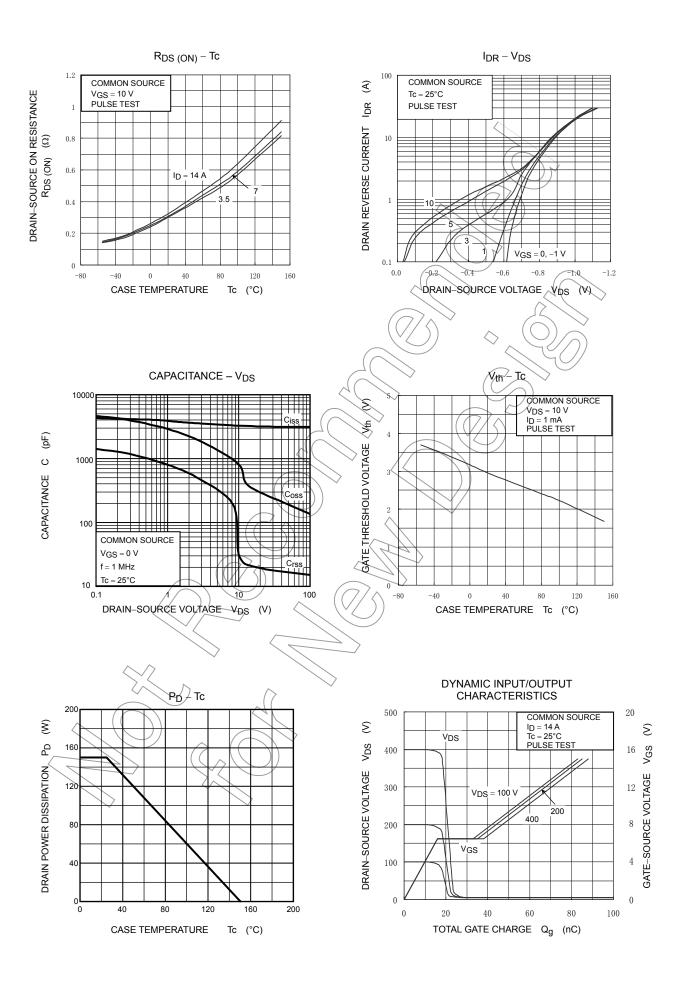
Note 4: A line under a Lot No. identifies the indication of product Labels.

[[G]]/RoHS COMPATIBLE or [[G]]/RoHS [[Pb]]

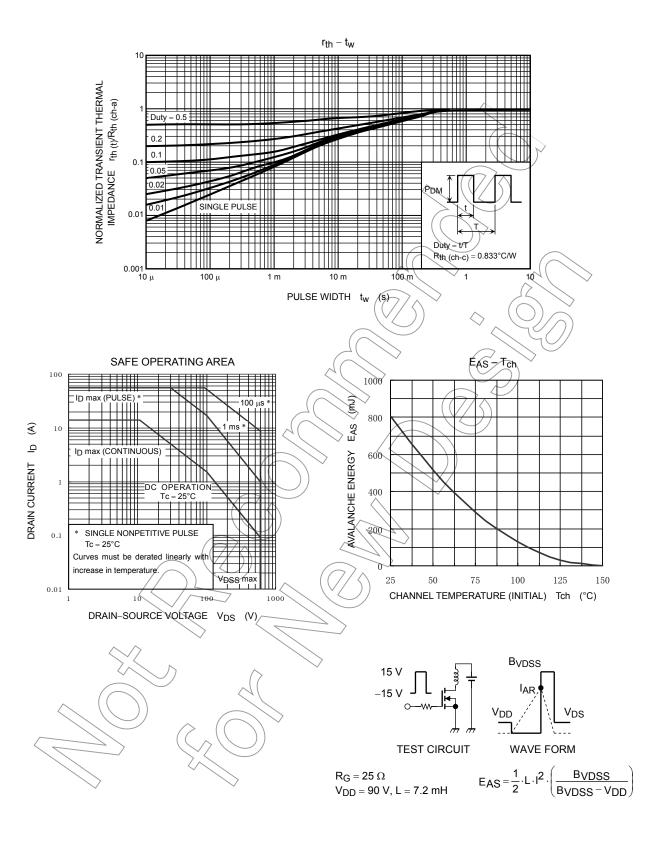
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